



# Product data sheet

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ESD5V0V1BCSF-MS

Semiconductor Compiance

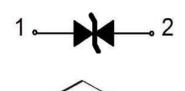
#### Features

- ♦ 60 Watts peak pulse power (tp = 8/20µs)
- Transient protection for high speed data lines to

IEC 61000-4-2 (ESD) ±30kV (air), ±30kV (contact)

IEC 61000-4-4 (EFT) 40A (5/50ns)

- Working voltages : 5V
- Protects One Power or I/O Port
- Low operating and clamping voltages
- Solid-state silicon avalanche technology





0201

- Applications
- Notebooks, Desktops, Servers and Video Graphics Cards
- USB Power & Data Line Protection
- Monitors and Flat Panel Displays
- I<sup>2</sup>C Bus Protection
- Portable Instrumentation
- Set Top Box

### Electrical Characteristics@ Ta=25°C unless otherwise

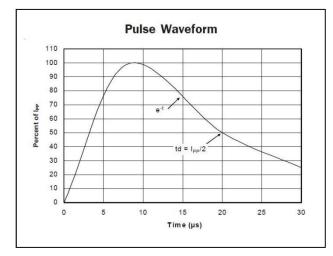
	VRWM @IR		VBR@ImA	VC@1A	Vc@	IPP	CJ
P/N	V	μA	V	V	V	А	pF
		MAX	MIN	MAX	MAX		MAX
ESD5V0V1BCSF-MS	5	1	5.6	9.8	12.5	5	5

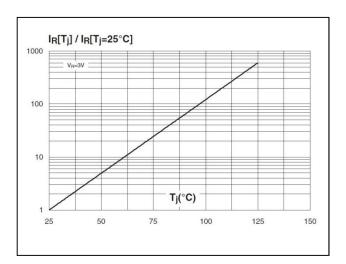
#### Maximum Rating @ Ta=25°C unless otherwise specified

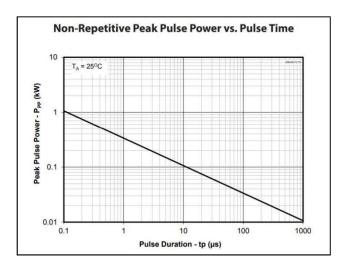
Symbol	Parameter	Ratings	Units
Ррк	Peak Pulse Power (tp = 8/20µs)	60	Watts
TL	Lead Soldering Temperature	260(10sec.)	°C
TJ	Operating Temperature	-55 to +150	°C
T <sub>STG</sub>	Storage Temperature	-55 to +150	°C

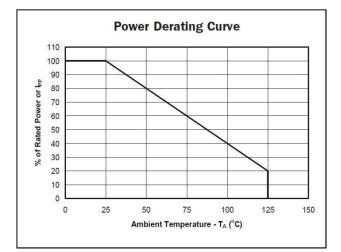


# Typical Characteristics@ Ta=25 $^\circ\!\!\mathbb{C}$ unless otherwise specified



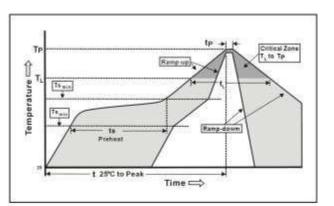






## Soldering Parameters

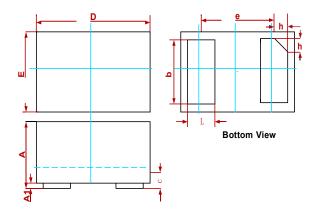
Reflow Condition		Fb – Free assembly	
Pre Heat	-Temperature Min (T <sub>s(Min)</sub> )	150°C	
	- Temperature Max (T <sub>s(Max)</sub> )	200°C	
	-Time (Min to max) (t_)	60 - 180 secs	
Average r (T <sub>i</sub> ) to pea	amp up rate (Liquidus) Temp Ik	3ºC/second Max	
T <sub>S (Max)</sub> to T <sub>L</sub> - Ramp-up Rate		3ºC/second Max	
Reflow	-Temperature (T <sub>1</sub> ) (Liquidus)	217°C	
	-Temperature (t <sub>i</sub> )	60 – 150 seconds	
Peak Temperature (T,)		250-0-5 °C	
Time within 5°C of actual peak Temperature (t,)		20 – 40 seconds	
Ramp-dowm Rate		6°C/second Max	
Time 25°C to peak Temperature (T <sub>p</sub> )		8 minutes Max.	
Do not exceed		260°C	





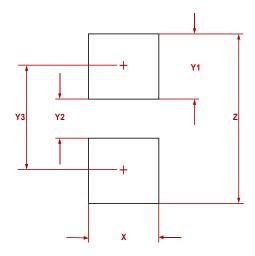


#### PACKAGE MECHANICAL DATA



	DIMENSIONS				
	MILLIMETERS				
SYM	MIN NOM		MAX		
А	0.230			0.330	
A1	0.000	0.020		0.050	
b	0.215	0.245		0.275	
С	0.120	0.150		0.180	
D	0.550	0.600		0.650	
е	0.355 BSC				
E	0.250 0.300			0.350	
L	0.160	0.190		0.220	
h	0.079 BSC				

#### Suggested Pad Layout



SYM	DIMENSIONS			
	MILLIMETERS	INCHES		
х	0.30	0.012		
Y1	0.25	0.010		
Y2	0.15	0.006		
Y3	0.40	0.016		
Z	0.65	0.026		

#### **REEL SPECIFICATION**

P/N	PKG	QTY
ESD5V0V1BCSF-MS	0201	15000



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